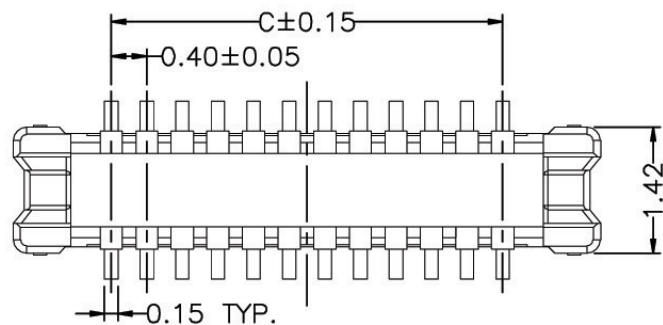


PIN NO.	A	B	C
10	3.80	3.20	1.60
12	4.20	3.60	2.00
16	5.00	4.40	2.80
20	5.80	5.20	3.60
24	6.60	6.00	4.40
30	7.80	7.20	5.60
34	8.60	8.00	6.40
40	9.80	9.20	7.60
50	11.80	11.20	9.60

SPECIFICATIONS:

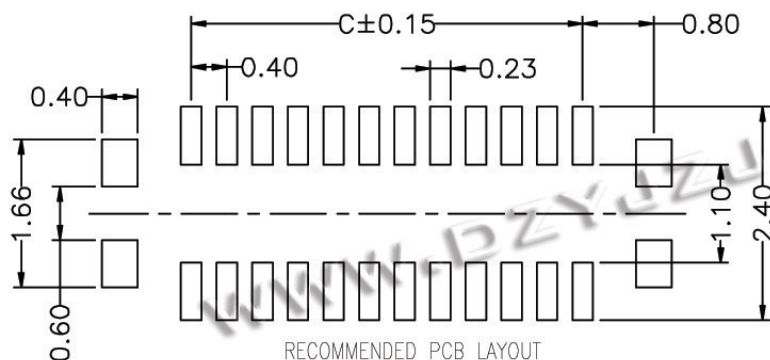
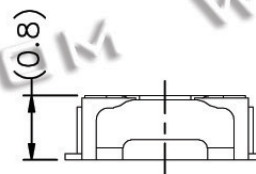
- 1.VOLTAGE/CURRENT RATING: 30V/0.3A AC;
- 2.WITHSTANDING VOLTAGE: 100V AC ONE MINUTE;
- 3.INSULATION RESISTANCE: 50M Ω MIN;
- 4.CONTACT RESISTANCE: 100m Ω MAX;
- 5.OPERATING TEMPERATURE RANGE: -35° C TO 85° C.

MATERIAL:

- 1.INSULATOR: LCP UL 94V-0 BLACK;
- 2.TERMINAL: COPPER ALLOY;
- 3.METAL FITTINGS: COPPER ALLOY.

PLATING:

- 1.TERMINAL: GOLD PLATING,
NICKEL 50u" MIN. OVER ALL;
- 2.METAL FITTINGS: TIN 100u" MIN. OVER NICKEL 50u"MIN.

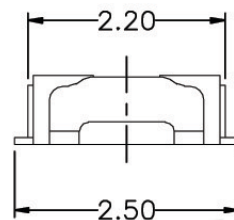
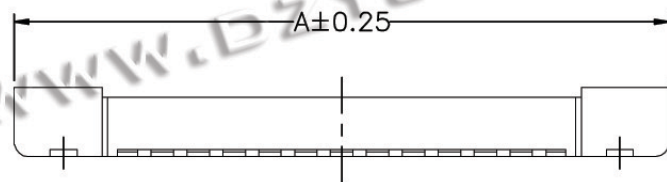
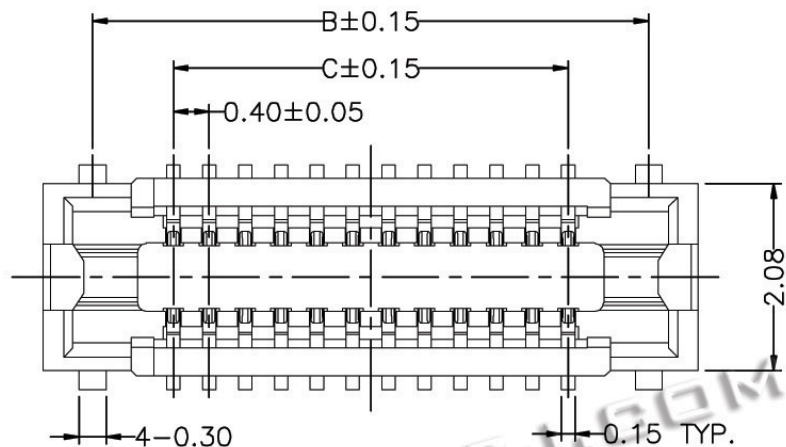
RECOMMENDED PCB LAYOUT
CONNECTOR SIDE

MATING SECTION



深圳市华宇创精密电子有限公司

TOLERANCE: X.X ±0.30 X.XX ±0.25 X.XXX ±0.15 X.* ±2° X.X* ±0.5° UNIT: mm [inch] SCALE:1:1 SIZE: A4	DRAWN BY : 陈一鸣	DATE : 2014-02-23	PART NAME: 0.4PH 单槽BTB 公座	
	CHECKED BY: 马跃	DATE : 2014-02-23	PART NO.	HYC13M-BTB2XN-080
	APPROVED BY: 柯南	DATE : 2014-02-23	MOLD NO.	
			DRAW NO:	HYC-1911201019
			SHEET NO.	1 OF 1

RECOMMENDED PCB LAYOUT
CONNECTOR SIDE

PIN NO.	A	B	C
10	4.50	3.40	1.60
12	4.90	3.80	2.00
16	5.70	4.60	2.80
20	6.50	5.40	3.60
24	7.30	6.20	4.40
30	8.50	7.40	5.60
34	9.30	8.20	6.40
40	10.50	9.40	7.60
50	12.50	11.40	9.60

SPECIFICATIONS:

- 1.VOLTAGE/CURRENT RATING: 30V/0.3A AC;
- 2.WITHSTANDING VOLTAGE: 100V AC ONE MINUTE;
- 3.INSULATION RESISTANCE: 50M Ω MIN;
- 4.CONTACT RESISTANCE: 100m Ω MAX;
- 5.OPERATING TEMPERATURE RANGE: -35° C TO 85° C.

MATERIAL:

- 1.INSULATOR: LCP UL 94V-0 BLACK;
- 2.TERMINAL: COPPER ALLOY;
- 3.METAL FITTINGS: COPPER ALLOY.

PLATING:

- 1.TERMINAL: GOLD PLATING,
NICKEL 50u" MIN. OVER ALL;
- 2.METAL FITTINGS: TIN 100u" MIN. OVER NICKEL 50u"MIN.



深圳市华宇创精密电子有限公司

TOLERANCE: X.X ±0.30 X.XX ±0.25 X.XXX ±0.15 X' ±2" X.X' ±0.5" UNIT: mm [inch] SCALE:1:1 SIZE: A4	DRAWN BY : 陈一鸣	DATE : 2014-02-23	PART NAME: 0.4PH 单槽BTB 母座	
	CHECKED BY: 马跃	DATE : 2014-02-23	PART NO.	HYC13F-BTB2XN-080
	APPROVED BY: 柯南	DATE : 2014-02-23	MOLD NO.	
			DRAW NO:	HYC-1911201024
			SHEET NO.	1 OF 1